# Chopper-Stabilized Precision Hall-Effect Switches 

## FEATURES AND BENEFITS

- AEC-Q100 automotive qualified
- Unipolar switchpoints
- Resistant to physical stress
- Superior temperature stability
- Output short-circuit protection
- Operation from unregulated supply
- Reverse-battery protection
- Solid-state reliability
- Small package sizes


## PACKAGES:

## Not to scale



## DESCRIPTION

The A1120, A1121, A1122, A1123, and A1125 Hall-effect unipolar switches are extremely temperature-stable and stress-resistant sensor ICs, especially suited for operation over extended temperature ranges to $150^{\circ} \mathrm{C}$. Superior hightemperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress.

Each device includes on a single silicon chip a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-drain output to sink up to 25 mA .

An on-board regulator permits operation with supply voltages of 3 to 24 V . The advantage of operating down to 3 V is that the device can be used in 3 V applications or with additional external resistance in series with the supply pin for greater protection against high-voltage transient events.

For the A1120, A1121, A1122, and A1123, a south pole of sufficient strength turns the output on. Removal of the magnetic field turns the output off. The A1125 is complementary, in that for these devices, a south pole turns the A1125 output off, and removal of the magnetic field turns the output on.

Two package styles provide a magnetically optimized package for most applications. Package type LH is a modified SOT23W, surface-mount package, while UA is a three-lead ultra-mini SIP for through-hole mounting. Each package type is lead $(\mathrm{Pb})$ free (suffix, -T ), with a $100 \%$ matte-tin-plated leadframe.

Functional Block Diagram


## Chopper-Stabilized Precision Hall-Effect Switches

## SELECTION GUIDE

| Part Number | Packing [1] | Mounting | Ambient, $\mathrm{T}_{\mathrm{A}}$ <br> ( ${ }^{\circ} \mathrm{C}$ ) | Switchpoints (Typ.) (G) |  | Output In South (Positive) Magnetic Field |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{B}_{\text {OP }}$ | $\mathrm{B}_{\mathrm{RP}}$ |  |
| A1120ELHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 85 | 35 | 25 |  |
| A1120ELHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1120EUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1120LLHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 150 |  |  |  |
| A1120LLHLT-T[2] | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1120LUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1121ELHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount |  | 95 | 70 |  |
| A1121ELHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount | -40 to 85 |  |  |  |
| A1121EUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1121LLHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 150 |  |  |  |
| A1121LLHLT-T[2] | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  | On (logic low) |
| A1121LUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1122ELHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount |  | 150 | 125 |  |
| A1122ELHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount | -40 to 85 |  |  |  |
| A1122EUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1122LLHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 150 |  |  |  |
| A1122LLHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1122LUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1123LLHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 150 | 280 | 225 |  |
| A1123LLHLT-T[2] | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1123LUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1125ELHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 85 | 35 | 25 | Off (logic high) |
| A1125ELHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1125EUA-T[3] | Bulk, 500 pieces/bag | 3-pin SIP through hole |  |  |  |  |
| A1125LLHLX-T | 13-in. reel, 10000 pieces/reel | 3-pin SOT23W surface mount | -40 to 150 |  |  |  |
| A1125LLHLT-T ${ }^{[2]}$ | 7-in. reel, 3000 pieces/reel | 3-pin SOT23W surface mount |  |  |  |  |
| A1125LUA-T[3] | Bulk, 500 pieces/bag | 3 -pin SIP through hole |  |  |  |  |

${ }^{1}$ Contact Allegro for additional packing options.
${ }^{2}$ Available through authorized Allegro distributors only.
${ }^{3}$ The chopper-style UA package is not for new design; the matrix HD style UA package is recommended for new designs.

ABSOLUTE MAXIMUM RATINGS

| Characteristic | Symbol | Notes | Rating | Units |
| :--- | :---: | :---: | :---: | :---: |
| Forward Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ |  | 26.5 | V |
| Reverse Supply Voltage | $\mathrm{V}_{\mathrm{RCC}}$ |  | -30 | V |
| Output Off Voltage | $\mathrm{V}_{\mathrm{OUT}}$ |  | 26 | V |
| Continuous Output Current | $\mathrm{I}_{\text {OUT }}$ |  | 25 | mA |
| Reverse Output Current | $\mathrm{I}_{\text {ROUT }}$ |  | -50 | mA |
| Operating Ambient Temperature |  | Range E | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | Range L | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | $\mathrm{T}_{\mathrm{J}}(\max )$ |  | 165 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ |  | -65 to 170 | ${ }^{\circ} \mathrm{C}$ |

## PINOUT DIAGRAMS AND TERMINAL LIST TABLE



Terminal List

| Name | Description | Number |  |
| :---: | :--- | :---: | :---: |
|  |  | Package LH | Package UA |
| VCC | Connects power supply to chip | 1 | 1 |
| VOUT | Output from circuit | 2 | 3 |
| GND | Ground | 3 | 2 |

ELECTRICAL CHARACTERISTICS: Valid over full operating voltage and ambient temperature ranges, unless otherwise noted

| Characteristics | Symbol | Test Conditions |  | Min. | Typ. [1] | Max. | Unit [2] |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ELECTRICAL CHARACTERISTICS |  |  |  |  |  |  |  |
| Forward Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | Operating, $\mathrm{T}_{\mathrm{J}}<165^{\circ} \mathrm{C}$ |  | 3 | - | 24 | V |
| Output Leakage Current | Ioutoff | $\begin{aligned} & \text { A1120 } \\ & \text { A1121 } \\ & \text { A1122 } \\ & \text { A1122 } \end{aligned}$ | $\mathrm{V}_{\text {OUT }}=24 \mathrm{~V}, \mathrm{~B}<\mathrm{B}_{\mathrm{RP}}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  |  | A1125 | $\mathrm{V}_{\text {OUT }}=24 \mathrm{~V}, \mathrm{~B}>\mathrm{B}_{\text {OP }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {OUT(SAT) }}$ | A1120 <br> A1121 <br> A1122 <br> A1123 | $\mathrm{l}_{\mathrm{OUT}}=20 \mathrm{~mA}, \mathrm{~B}>\mathrm{B}_{\text {OP }}$ | - | 185 | 500 | mV |
|  |  | A1125 | $\mathrm{l}_{\text {OUT }}=20 \mathrm{~mA}, \mathrm{~B}<\mathrm{B}_{\mathrm{RP}}$ | - | 185 | 500 | mV |
| Output Current Limit | $\mathrm{IOM}^{\text {a }}$ | $\begin{aligned} & \text { A1120 } \\ & \text { A1121 } \\ & \text { A1122 } \\ & \text { A1123 } \end{aligned}$ | $\mathrm{B}>\mathrm{B}_{\mathrm{OP}}$ | 30 | - | 60 | mA |
|  |  | A1125 | $B<B_{R P}$ | 30 | - | 60 | mA |
| Power-On Time [3] | $t_{\text {PO }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}>3.0 \mathrm{~V}, \mathrm{~B}<\mathrm{B}_{\mathrm{RP}}(\min )-10 \mathrm{G}, \\ & \mathrm{~B}>\mathrm{B}_{\mathrm{OP}}(\max )+10 \mathrm{G} \\ & \hline \end{aligned}$ |  | - | - | 25 | $\mu \mathrm{s}$ |
| Chopping Frequency | $\mathrm{f}_{\mathrm{C}}$ |  |  | - | 800 | - | kHz |
| Output Rise Time [3][4] | $\mathrm{t}_{\mathrm{r}}$ | $\mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{S}}=20 \mathrm{pF}$ |  | - | 0.2 | 2 | $\mu \mathrm{s}$ |
| Output Fall Time [3][4] | $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{S}}=20 \mathrm{pF}$ |  | - | 0.1 | 2 | $\mu \mathrm{s}$ |
| Supply Current | $\mathrm{I}_{\mathrm{CC}(\mathrm{ON})}$ | A1120 <br> A1121 <br> A1122 <br> A1123 | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{~B}>\mathrm{B}_{\mathrm{OP}}$ | - | - | 4 | mA |
|  |  | A1125 | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{~B}<\mathrm{B}_{\mathrm{RP}}$ | - | - | 4 | mA |
|  | $\mathrm{I}_{\text {CC(OFF) }}$ | A1120 <br> A1121 <br> A1122 <br> A1123 | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{~B}<\mathrm{B}_{\mathrm{RP}}$ | - | - | 4 | mA |
|  |  | A1125 | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{~B}>\mathrm{B}_{\mathrm{OP}}$ | - | - | 4 | mA |
| Reverse Supply Current | $\mathrm{I}_{\mathrm{RCC}}$ | $\mathrm{V}_{\mathrm{RCC}}=-30 \mathrm{~V}$ |  | - | - | -5 | mA |
| Supply Zener Clamp Voltage | $\mathrm{V}_{\mathrm{z}}$ | $\mathrm{I}_{\mathrm{CC}}=5 \mathrm{~mA} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 28 | - | - | V |
| Zener Impedance | $\mathrm{I}_{\mathrm{z}}$ | $\mathrm{I}_{\mathrm{CC}}=5 \mathrm{~mA} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | - | 50 | - | $\Omega$ |

Continued on the next page...

## Chopper-Stabilized Precision Hall-Effect Switches

ELECTRICAL CHARACTERISTICS (continued): Valid over full operating voltage and ambient temperature ranges, unless otherwise noted

| Characteristics | Symbol | Test Conditions |  | Min. | Typ. ${ }^{[1]}$ | Max. | Unit [2] |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MAGNETIC CHARACTERISTICS |  |  |  |  |  |  |  |
| Operate Point | $\mathrm{B}_{\mathrm{OP}}$ | A1120 |  | - | 35 | 50 | G |
|  |  | A1121 |  | 50 | 95 | 135 | G |
|  |  | A1122 |  | 120 | 150 | 200 | G |
|  |  | A1123 |  | 205 | 280 | 355 | G |
|  |  | A1125 |  | - | 35 | 50 | G |
| Release Point | $\mathrm{B}_{\text {RP }}$ | A1120 |  | 5 | 25 | - | G |
|  |  | A1121 |  | 40 | 70 | 110 | G |
|  |  | A1122 |  | 110 | 125 | 190 | G |
|  |  | A1123 |  | 150 | 225 | 300 | G |
|  |  | A1125 |  | 5 | 25 | - | G |
| Hysteresis | $\mathrm{B}_{\mathrm{HYS}}$ | A1120 | $\left(B_{O P}-B_{R P}\right)$ | - | 10 | - | G |
|  |  | A1121 |  | 10 | 25 | 42 | G |
|  |  | A1122 |  | 10 | 25 | 42 | G |
|  |  | A1123 |  | 30 | 55 | 80 | G |
|  |  | A1125 |  | - | 10 | - | G |

[^0]A1120, A1121, A1122, A1123, and A1125

## Chopper-Stabilized Precision Hall-Effect Switches

THERMAL CHARACTERISTICS: May require derating at maximum conditions; see application information

| Characteristic | Symbol | Test Conditions | Value | Units |
| :---: | :---: | :---: | :---: | :---: |
| Package Thermal Resistance | $\mathrm{R}_{\text {өJA }}$ | Package LH, 1-layer PCB with copper limited to solder pads | 228 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | Package LH, 2-layer PCB with 0.463 in ? of copper area each side connected by thermal vias | 110 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | Package UA, 1-layer PCB with copper limited to solder pads | 165 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |




A1120, A1121, A1122,
A1123, and A1125

# Chopper-Stabilized Precision Hall-Effect Switches 

## Characteristic Performance A1120, A1121, A1122, A1123, and A1125 Electrical Characteristics







A1120, A1121, A1122,
A1123, and A1125

## Chopper-Stabilized Precision Hall-Effect Switches

## A1120 and A1125 Magnetic Characteristics








A1120, A1121, A1122,
A1123, and A1125

# Chopper-Stabilized Precision Hall-Effect Switches 

## A1121 Magnetic Characteristics








A1120, A1121, A1122,
A1123, and A1125

# Chopper-Stabilized Precision Hall-Effect Switches 

## A1122 Magnetic Characteristics








A1120, A1121, A1122,
A1123, and A1125

# Chopper-Stabilized Precision Hall-Effect Switches 

## A1123 Magnetic Characteristics








# Chopper-Stabilized Precision Hall-Effect Switches 

## Functional Description

## Operation

The output of the A1120, A1121, A1122, and A1123 devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold, $\mathrm{B}_{\mathrm{OP}}$ (see panel A of figure 1). When the magnetic field is reduced below the release point, $\mathrm{B}_{\mathrm{RP}}$, the device output goes high (turns off). The output of the A1125 devices switches high (turns off) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold, $\mathrm{B}_{\mathrm{OP}}$ (see panel B of figure 1 ). When the magnetic field is reduced below the release point, $B_{R P}$, the device output goes low (turns on).

After turn-on, the output voltage is $\mathrm{V}_{\mathrm{OUT}(\mathrm{SAT})}$. The output transistor is capable of sinking current up to the short circuit current limit, $\mathrm{I}_{\mathrm{OM}}$, which is a minimum of 30 mA .

The difference in the magnetic operate and release points is the hysteresis, $\mathrm{B}_{\mathrm{HYS}}$, of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise. Powering-on the device in the hysteresis range (less than $\mathrm{B}_{\mathrm{OP}}$ and higher than $\mathrm{B}_{\mathrm{RP}}$ ) will
give an indeterminate output state. The correct state is attained after the first excursion beyond $\mathrm{B}_{\mathrm{OP}}$ or $\mathrm{B}_{\mathrm{RP}}$.

## Applications

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce external noise in the application. As is shown in panel B of figure 1 , a $0.1 \mu \mathrm{~F}$ capacitor is typical.

Extensive applications information for Hall effect devices is available in:

- Hall-Effect IC Applications Guide, Application Note 27701
- Guidelines for Designing Subassemblies Using Hall-Effect

Devices, Application Note 27703.1

- Soldering Methods for Allegro's Products - SMT and ThroughHole, Application Note 26009

All are provided on the Allegro Web site, www.allegromicro.com.


Figure 1. Device switching behavior. In panels $A$ and $B$, on the horizontal axis, the $B+$ direction indicates increasing south polarity magnetic field strength. This behavior can be exhibited when using an electrical circuit such as that shown in panel $C$.

# Chopper-Stabilized Precision Hall-Effect Switches 

## Chopper Stabilization Technique

When using Hall effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall element. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges.

Chopper stabilization is a unique approach used to minimize Hall offset on the chip. The Allegro technique, namely Dynamic Quadrature Offset Cancellation, removes key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulation-demodulation process. The undesired offset signal is separated from the magnetic field-induced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field induced signal to recover its original spectrum at baseband, while the dc offset becomes a high-frequency signal. The magnetic sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed. This configuration is illustrated in figure 2.

The chopper stabilization technique uses a 400 kHz high frequency clock. For demodulation process, a sample and hold technique is used, where the sampling is performed at twice the chopper frequency ( 800 kHz ). This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signal-processing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

The repeatability of magnetic field-induced switching is affected slightly by a chopper technique. However, the Allegro high frequency chopping approach minimizes the affect of jitter and makes it imperceptible in most applications. Applications that are more likely to be sensitive to such degradation are those requiring precise sensing of alternating magnetic fields; for example, speed sensing of ring-magnet targets. For such applications, Allegro recommends its digital device families with lower sensitivity to jitter. For more information on those devices, contact your Allegro sales representative.


Figure 2. Model of chopper stabilization technique

## Chopper-Stabilized Precision Hall-Effect Switches

## Power Derating

The device must be operated below the maximum junction temperature of the device, $\mathrm{T}_{\mathrm{J}(\max )}$. Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating $\mathrm{T}_{\mathrm{J}}$. (Thermal data is also available on the Allegro MicroSystems website.)
The Package Thermal Resistance, $\mathrm{R}_{\theta \mathrm{JA}}$, is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity, K, of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case, $\mathrm{R}_{\theta \mathrm{JC}}$, is relatively small component of $R_{\theta J A}$. Ambient air temperature, $T_{A}$, and air motion are significant external factors, damped by overmolding.
The effect of varying power levels (Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ ), can be estimated. The following formulas represent the fundamental relationships used to estimate $T_{\mathrm{J}}$, at $\mathrm{P}_{\mathrm{D}}$.

$$
\begin{align*}
& \mathrm{P}_{\mathrm{D}}=\mathrm{V}_{\mathrm{IN}} \times \mathrm{I}_{\mathrm{IN}}  \tag{1}\\
& \Delta \mathrm{~T}=\mathrm{P}_{\mathrm{D}} \times \mathrm{R}_{\theta \mathrm{JA}}  \tag{2}\\
& \mathrm{~T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{A}}+\Delta \mathrm{T} \tag{3}
\end{align*}
$$

For example, given common conditions such as: $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{I}_{\mathrm{CC}}=1.6 \mathrm{~mA}$, and $\mathrm{R}_{\theta \mathrm{JA}}=165^{\circ} \mathrm{C} / \mathrm{W}$, then:

$$
\begin{aligned}
& \mathrm{P}_{\mathrm{D}}=\mathrm{V}_{\mathrm{CC}} \times \mathrm{I}_{\mathrm{CC}}=12 \mathrm{~V} \times 1.6 \mathrm{~mA}=19 \mathrm{~mW} \\
& \Delta \mathrm{~T}=\mathrm{P}_{\mathrm{D}} \times \mathrm{R}_{\theta J \mathrm{~A}}=19 \mathrm{~mW} \times 165^{\circ} \mathrm{C} / \mathrm{W}=3^{\circ} \mathrm{C} \\
& \mathrm{~T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{A}}+\Delta \mathrm{T}=25^{\circ} \mathrm{C}+3^{\circ} \mathrm{C}=28^{\circ} \mathrm{C}
\end{aligned}
$$

A worst-case estimate, $\mathrm{P}_{\mathrm{D}(\max )}$, represents the maximum allowable power level ( $\left.\mathrm{V}_{\mathrm{CC}(\max )}, \mathrm{I}_{\mathrm{CC}(\max )}\right)$, without exceeding $\mathrm{T}_{\mathrm{J}(\max )}$, at a selected $\mathrm{R}_{\text {日JA }}$ and $\mathrm{T}_{\mathrm{A}}$.
Example: Reliability for $\mathrm{V}_{\mathrm{CC}}$ at $\mathrm{T}_{\mathrm{A}}=150^{\circ} \mathrm{C}$, package LH , using a minimum-K PCB.

Observe the worst-case ratings for the device, specifically:
$\mathrm{R}_{\theta \mathrm{JA}}=228^{\circ} \mathrm{C} / \mathrm{W}, \mathrm{T}_{\mathrm{J}}($ max $)=165^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}(\max )=24 \mathrm{~V}$, and $\mathrm{I}_{\mathrm{CC}}(\max )=4 \mathrm{~mA}$.
Calculate the maximum allowable power level, $\mathrm{P}_{\mathrm{D}}(\max )$. First, invert equation 3:

$$
\Delta \mathrm{T}_{\max }=\mathrm{T}_{\mathrm{J}}(\max )-\mathrm{T}_{\mathrm{A}}=165^{\circ} \mathrm{C}-150^{\circ} \mathrm{C}=15^{\circ} \mathrm{C}
$$

This provides the allowable increase to $\mathrm{T}_{\mathrm{J}}$ resulting from internal power dissipation. Then, invert equation 2 :

$$
P_{D}(\max )=\Delta T_{\max } \div \mathrm{R}_{\theta J \mathrm{~A}}=15^{\circ} \mathrm{C} \div 228^{\circ} \mathrm{C} / \mathrm{W}=66 \mathrm{~mW}
$$

Finally, invert equation 1 with respect to voltage:

$$
\mathrm{V}_{\mathrm{CC}(\text { est })}=\mathrm{P}_{\mathrm{D}}(\max ) \div \mathrm{I}_{\mathrm{CC}}(\max )=66 \mathrm{~mW} \div 4 \mathrm{~mA}=16.5 \mathrm{~V}
$$

The result indicates that, at $\mathrm{T}_{\mathrm{A}}$, the application and device can dissipate adequate amounts of heat at voltages $\leq \mathrm{V}_{\mathrm{CC}(\text { est })}$.
Compare $\mathrm{V}_{\mathrm{CC}(\text { est })}$ to $\mathrm{V}_{\mathrm{CC}}($ max $)$. If $\mathrm{V}_{\mathrm{CC}(\text { est })} \leq \mathrm{V}_{\mathrm{CC}}($ max $)$, then reliable operation between $\mathrm{V}_{\mathrm{CC}(\text { est })}$ and $\mathrm{V}_{\mathrm{CC}}(\max )$ requires enhanced $R_{\theta J \mathrm{~A}}$. If $\mathrm{V}_{\text {CC(est) }} \geq \mathrm{V}_{\mathrm{CC}}$ (max), then operation between $\mathrm{V}_{\mathrm{CC}(\text { est })}$ and $\mathrm{V}_{\mathrm{CC}}(\max )$ is reliable under these conditions.

# Chopper-Stabilized Precision Hall-Effect Switches 

Package LH, 3-Pin (SOT-23W)


Package UA, 3-Pin SIP, Matrix Style


A1120, A1121, A1122, A1123, and A1125

Chopper-Stabilized Precision Hall-Effect Switches

Package UA, 3-Pin SIP, Chopper Style


# Chopper-Stabilized Precision Hall-Effect Switches 

## Revision History

| Number | Date |  |
| :---: | :---: | :--- |
| 15 | September 3,2013 | Update product offerings; <br> Update UA package drawing |
| 16 | September 16, 2015 | Added AEC-Q100 qualification under Features and Benefits |
| 17 | November 4, 2016 | Chopper-style UA package designated as not for new design |

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[^0]:    ${ }^{1}$ Typical data are are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$, and are for initial design estimations only.
    21 G (gauss) $=0.1 \mathrm{mT}$ (millitesla).
    ${ }^{3}$ Guaranteed by device design and characterization.
    ${ }^{4} \mathrm{C}_{\mathrm{S}}=$ oscilloscope probe capacitance.

